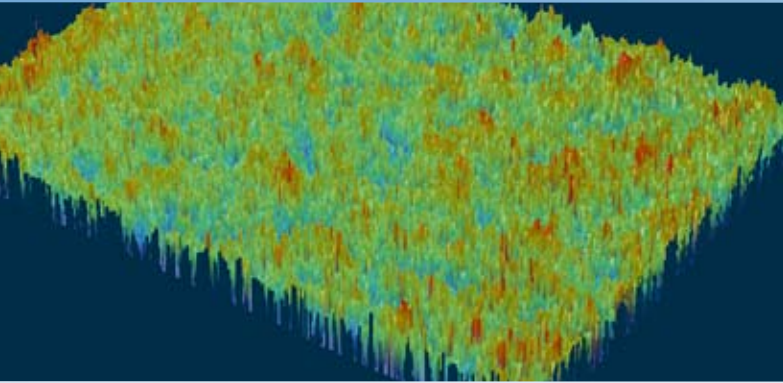


PCB / PCM

Höllmüller EVOLUTION
Oxide

R | E | N | A | ●



Uniform treatment for highest adherence of your resin on copper

Improved bonding performances and greater stability for new and common dielectrics.

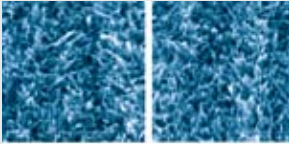
Areas of application

- Genuine "Black Oxide" process
- Commercial oxide replacement processes

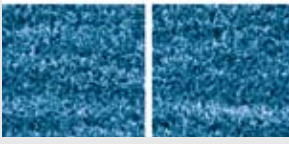
Features and benefits

- Operating elements clearly placed and easily accessible
- Specific designed fluid dynamics for uniform results
- Laminar flow treatment with little turbulence
- Highly-textured and passivated surface coating
- Inline cartridge filtration
- Small sumps with sloped bottoms to drain
- Overwidth available
- Optimised inner layer transport system to avoid surface damages
 - down to 25 μm (1 mil) core





Surface topographies

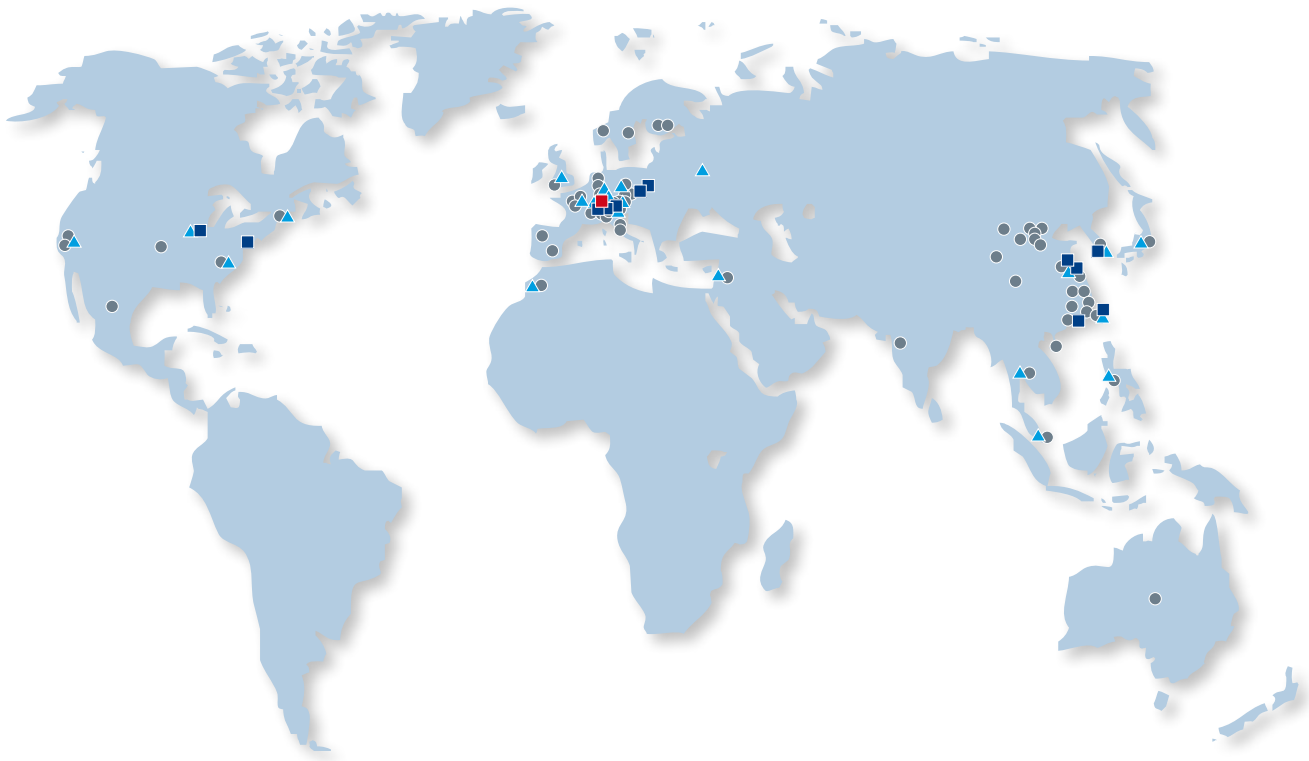


Front detail

RENA



Worldwide Service Centers



- HEADQUARTERS
- LOCATIONS
- INSTALLED BASE
- ▲ SERVICE CENTERS